

May 1993 Revised March 1999

74LVX02

Low Voltage Quad 2-Input NOR Gate

General Description

The LVX02 contains four 2-input NOR gates. The inputs tolerate voltages up to 7V allowing the interface of 5V systems to 3V systems.

Features

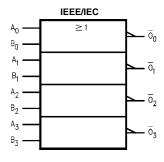
- Input voltage level translation from 5V to 3V
- Ideal for low power/low noise 3.3V applications
- Guaranteed simultaneous switching noise level and dynamic threshold performance

Ordering Code

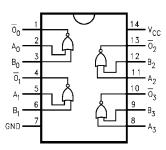
Order Number	Package Number	Package Description
74LVX02M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
74LVX02SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LVX02MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description			
A _n , B _n	Inputs			
Ōn	Outputs			

Absolute Maximum Ratings(Note 1)

Supply Voltage (V $_{CC}$) -0.5V to +7.0V

DC Input Diode Current (I_{IK})

 $\label{eq:V1} V_{I} = -0.5 \text{V} \\ \text{DC Input Voltage (V_{I})} \\ -0.5 \text{V to 7V} \\$

DC Output Diode Current (I_{OK})

$$\begin{split} V_{O} = -0.5V & -20 \text{ mA} \\ V_{O} = V_{CC} + 0.5V & +20 \text{ mA} \end{split}$$

DC Output Voltage (V_O) -0.5V to $V_{CC} + 0.5V$

DC Output Source

or Sink Current (I_O) ±25 mA

 $\label{eq:cond} \mbox{DC V}_{\mbox{CC}} \mbox{ or Ground Current}$

 $(I_{CC} \text{ or } I_{GND})$ ±50 mA

Storage Temperature (T_{STG}) $-65^{\circ}C$ to $+150^{\circ}C$

Power Dissipation 180 mW

Recommended Operating Conditions (Note 2)

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C			$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions		
Cyllibol	i diametei		Min	Тур	Max	Min	Max	Oille	Conditions		
V _{IH}	HIGH Level Input	2.0	1.5			1.5					
	Voltage	3.0	2.0			2.0		V			
		3.6	2.4			2.4					
V _{IL}	LOW Level Input	2.0			0.5		0.5				
	Voltage	3.0			0.8		0.8	V			
		3.6			0.8		0.8				
V _{OH}	HIGH Level Output	2.0	1.9	2.0		1.9			$V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -50 \mu$		
	Voltage	3.0	2.9	3.0		2.9		V	$I_{OH} = -50 \mu M_{OH}$		
		3.0	2.58			2.48			$V_{IN} = V_{IL} \text{ or } V_{IH} $ $I_{OH} = -50 \mu\text{J}$ $I_{OH} = -50 \mu\text{J}$ $I_{OH} = -4 \text{ mA}$		
V _{OL}	LOW Level Output	2.0		0.0	0.1		0.1		$V_{IN} = V_{IL} \text{ or } V_{IH} I_{OL} = 50 \mu\text{A}$		
	Voltage	3.0		0.0	0.1		0.1	V	$I_{OL} = 50 \mu A$ $I_{OL} = 4 m A$		
		3.0			0.36		0.44		I _{OL} = 4 mA		
I _{IN}	Input Leakage Current	3.6			±0.1		±1.0	μΑ	V _{IN} = 5.5V or GND		
I _{CC}	Quiescent Supply Current	3.6			2.0		20.0	μΑ	V _{IN} = V _{CC} or GND		

Noise Characteristics (Note 3)

Symbol	Parameter	V _{CC} (V)	$T_A = 25^{\circ}C$		Units	Conditions	
Cymbol	T di difficio		Тур	Limit	Omis	C _L (pF)	
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3	0.3	0.5	V	50	
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3	-0.3	-0.5	V	50	
V_{IHD}	Minimum HIGH Level Dynamic Input Voltage	3.3		2.0	V	50	
V _{ILD}	Maximum LOW Level Dynamic Input Voltage	3.3		0.8	V	50	

Note 3: Input $t_r = t_f = 3ns$

AC Electrical Characteristics

Symbol	Parameter	V _{CC}	T _A = +25°C			T _A = -40°0	C to +85°C	Units	C _L	
		(V)	Min	Тур	Max	Min	Max	Oilles	(pF)	
t _{PLH}	Propagation Delay Time	2.7		5.9	10.7	1.0	13.5		15	
t _{PHL}				8.4	14.2	1.0	17.0	ns	50	
		3.3 ± 0.3		4.5	6.6	1.0	8.0	115	15	
				7.0	10.1	1.0	11.5		50	
t _{OSLH}	Output to Output Skew	2.7			1.5		1.5	ns	50	
toshl	(Note 4)	3.3			1.5		1.5	115		

Note 4: Parameter guaranteed by design. $t_{OSLH} = |t_{PLHm}t_{PLHm}|$, $t_{OSHL} = |t_{PHLm}-t_{PHLm}|$

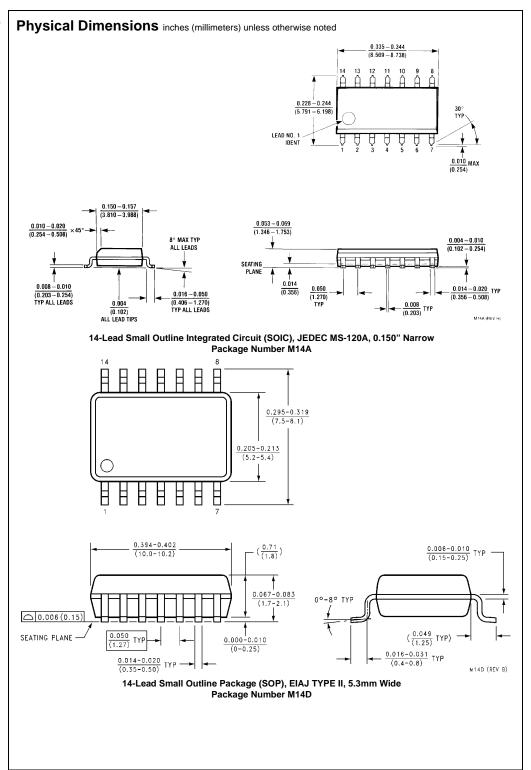
Capacitance

Symbol	Parameter		T _A = +25°C		T _A = -40°0	Units	
	i arameter	Min	Тур	Max	Min	Max	Oilles
C _{IN}	Input Capacitance		4	10		10	pF
C _{PD}	Power Dissipation		15				pF
	Capacitance (Note 5)						

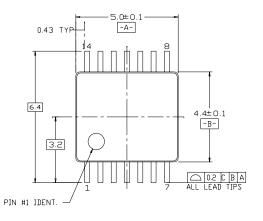
Note 5: Cpp is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

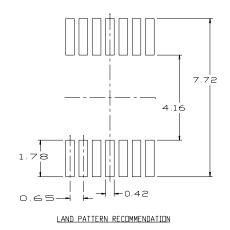
Average operating current can be obtained by the equation:

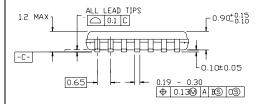
Average operating current can be obtained by the equation: $|_{CC(opr.)} = \frac{C_{PD} \times v_{CC} \times f_{IN} + |_{CC}}{4 \text{ (per Gate)}}$



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



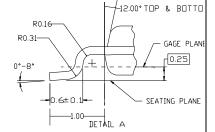






NOTES

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB-REF NOTE 6, DATED 7/93
- B. DIMENSIONS ARE IN MILLIMETERS
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS



14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC14

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